This special issue is intended to promote results presented at the 3th annual IEEE International Conference on Digital Twins and Parallel Intelligence (DTPI 2023) held from October 16th, 2023 to November 9th, 2023 in Macau, SARC and Florida, USA, with more depth and details at the journal article level with archival value. The submitted papers will undergo peer review similar to regular JRFID papers. The manuscript must be significantly extended beyond the scope of the conference paper in terms of the overall technical contents and research results (a similarity percent match less than 30% is mandatory). The submission deadline is January 31, 2024. Nevertheless, submissions in advance with respect to the deadline are strongly encouraged, since the accepted manuscripts will be published as Early Access documents on IEEE Xplore as soon as the final files are submitted by the authors.

Submission guidelines
The following requirements must be accounted for when submitting the manuscript:
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Submission deadline: JANUARY 31, 2024
Publication of the Special Issue: mid 2024